

High-speed switching diodes Rev. 07 — 31 January 2007

Product data sheet

Product profile 1.

1.1 General description

Single high-speed switching diodes, fabricated in planar technology, and encapsulated in small hermetically sealed glass SOD80C Surface-Mounted Device (SMD) packages.

Table 1. **Product overview**

Type number	Package	Configuration
PMLL4148L	SOD80C	single
PMLL4448		

1.2 Features

- High switching speed: $t_{rr} \le 4$ ns
- Reverse voltage: $V_R \le 75 V$
- Repetitive peak reverse voltage: V_{RRM} ≤ 100 V
- Repetitive peak forward current: I_{FRM} ≤ 450 mA
- Small hermetically sealed glass SMD package

1.3 Applications

- High-speed switching
- Reverse polarity protection

1.4 Quick reference data

Table 2. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _F	forward current		<u>[1]</u> _	-	200	mA
I _{FRM}	repetitive peak forward current		-	-	450	mA
V _R	reverse voltage		-	-	75	V



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Table 2.						
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _F	forward voltage					
	PMLL4148L	I _F = 50 mA	-	-	1	V
	PMLL4448	$I_F = 5 \text{ mA}$	620	-	720	mV
		I _F = 100 mA	-	-	1	V
t _{rr}	reverse recovery time		[2] _	-	4	ns

Table 2. Quick reference data continued

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

When switched from I_F = 10 mA to I_R = 60 mA; R_L = 100 Ω ; measured at I_R = 1 mA. [2]

Pinning information 2.

Pin	Description	Simplified outline	Symbol
1	cathode	[1]	
2	anode	k	K
			sym006

Ordering information 3.

Table 4. Orde	ering informa	tion	
Type number	Package		
	Name	Description	Version
PMLL4148L	-	hermetically sealed glass surface-mounted package;	SOD80C
PMLL4448		2 connectors	

Marking 4.

Type numberMarking code ^[1] PMLL4148Lmarking band	
PMLL4148L marking band	
PMLL4448 marking band	

[1] black: made in Philippines brown: made in China

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5. Limiting values

Limiting values nce with the Absolute Maximum	Rating System (IE	EC 60134).		
Parameter	Conditions	Min	Max	Unit
repetitive peak reverse voltage		-	100	V
reverse voltage		-	75	V
forward current		<u>[1]</u> -	200	mA
repetitive peak forward current		-	450	mA
non-repetitive peak forward	square wave	[2]		
current	t _p = 1 μs	-	4	А
	t _p = 1 ms	-	1	А
	t _p = 1 s	-	0.5	А
total power dissipation	T _{amb} = 25 °C	<u>[1]</u> -	500	mW
junction temperature		-	200	°C
ambient temperature		-65	+200	°C
storage temperature		-65	+200	°C
	Ince with the Absolute Maximum Parameter repetitive peak reverse voltage reverse voltage forward current repetitive peak forward current non-repetitive peak forward current non-repetitive peak forward current total power dissipation junction temperature ambient temperature	name with the Absolute Maximum Rating System (IE Parameter Conditions repetitive peak reverse voltage	nce with the Absolute Maximum Rating System (IEC 60134).ParameterConditionsMinrepetitive peak reverse voltage-reverse voltage-forward current[1]repetitive peak forward current-non-repetitive peak forward current-non-repetitive peak forward current- $t_p = 1 \ \mu s$ - $t_p = 1 \ \mu s$ - $t_p = 1 \ s$ -total power dissipation $T_{amb} = 25 \ ^{\circ}C$ junction temperature-ambient temperature-65	nce with the Absolute Maximum Rating System (IEC 60134).ParameterConditionsMinMaxrepetitive peak reverse voltage-100reverse voltage-75forward current[1]-200repetitive peak forward current-450non-repetitive peak forward current-4 $t_p = 1 \ \mu s$ -4 $t_p = 1 \ ms$ -1total power dissipationTamb = 25 °C[1]-junction temperature-200ambient temperature-65+200

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] $T_i = 25 \,^{\circ}C$ prior to surge.

6. Thermal characteristics

Table 7.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	<u>[1]</u> _	-	350	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point		-	-	300	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

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7. Characteristics

Symbol	Parameter	Conditions	Mi	n	Тур	Max	Unit
V _F	forward voltage						
	PMLL4148L	I _F = 50 mA	-		-	1	V
	PMLL4448	$I_F = 5 \text{ mA}$	62	0	-	720	mV
		I _F = 100 mA	-		-	1	V
I _R reverse current	reverse current	V _R = 20 V	-		-	25	nA
		V_R = 20 V; T_j = 150 °C	-		-	50	μA
R	reverse current						
	PMLL4448	V_R = 20 V; T_j = 100 °C	-		-	3	μA
C _d	diode capacitance	V _R = 0 V; f = 1 MHz	-		-	4	pF
t _{rr}	reverse recovery time		<u>[1]</u> -		-	4	ns
V _{FR}	forward recovery voltage		[2] _		-	2.5	V

[1] When switched from I_F = 10 mA to I_R = 60 mA; R_L = 100 $\Omega;$ measured at I_R = 1 mA.

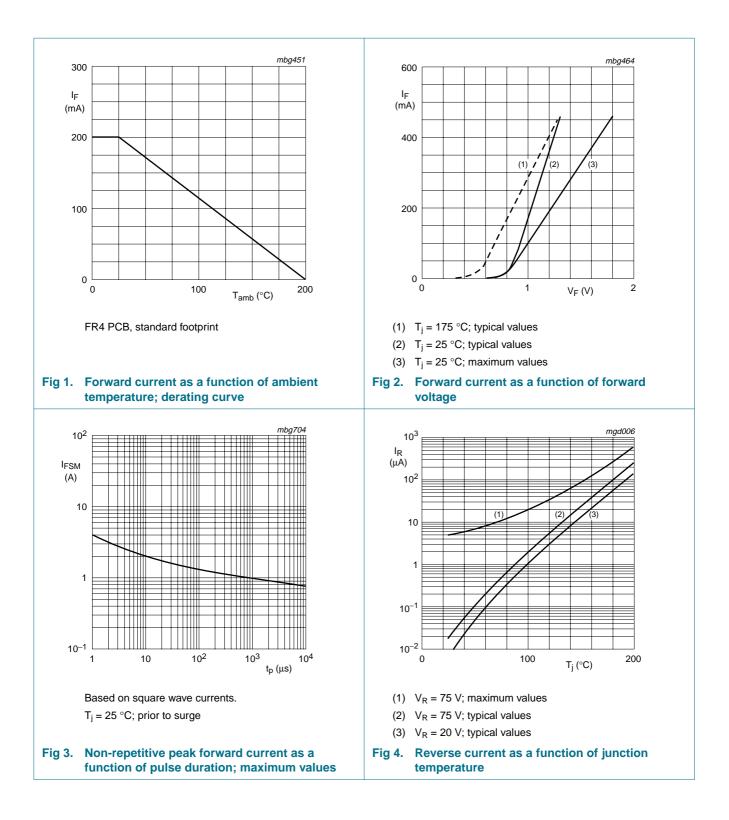
[2] When switched from I_F = 50 mA; t_r = 20 ns.

PMLL4148L_PMLL4448_7

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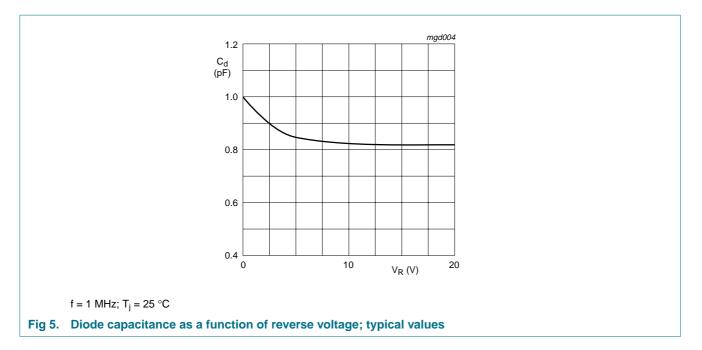


PMLL4148L_PMLL4448_7

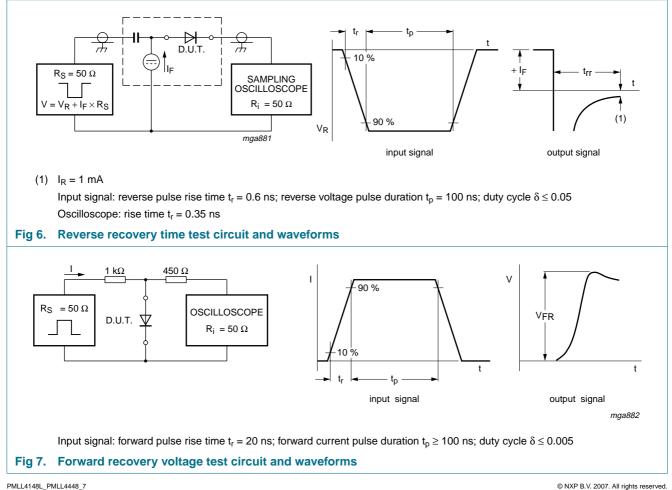
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Test information 8.



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9. Package outline

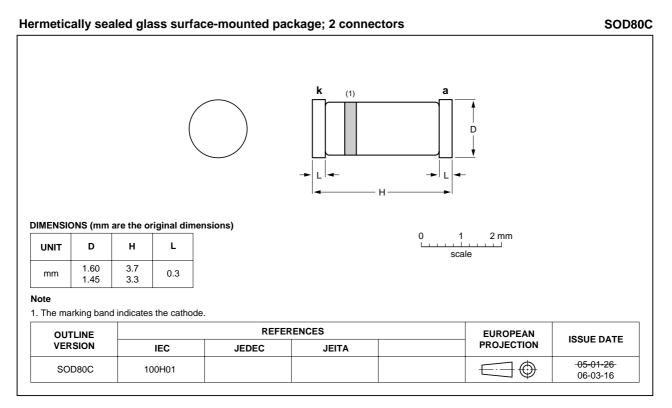


Fig 8. Package outline SOD80C

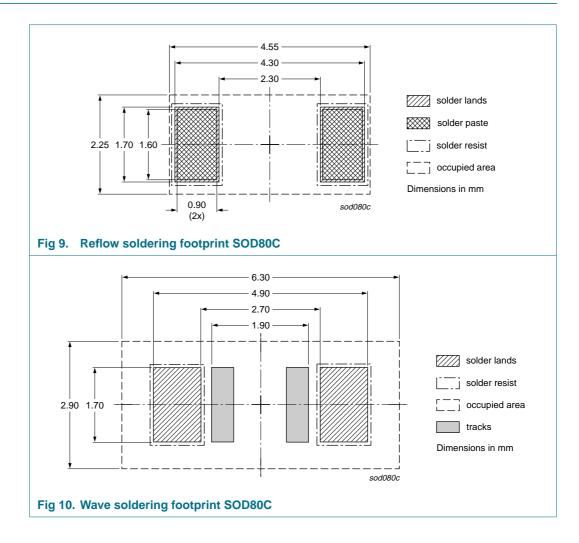
10. Packing information

	king method xx are the la	ls st three digits of the 12NC ordering co	ode.[<u>1]</u>	
Type number	Package	Description	Packing	quantity
			2500	10000
PMLL4148L	SOD80C	4 mm pitch, 8 mm tape and reel	-115	-135
PMLL4448				

[1] For further information and the availability of packing methods, see Section 14.

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11. Soldering



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12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
PMLL4148L_PMLL4448_7	20070131	Product data sheet	-	PMLL4148L_PMLL4448_6	
Modifications:		of this data sheet has beer of NXP Semiconductors.	n redesigned to com	ply with the new identity	
	 Legal texts have been adapted to the new company name where appropriate. 				
	Section 1.2	"Features": adapted			
	• Section 1.3	"Applications": amended			
	Table 2 "Qu	ick reference data": V _F con	ditions for PMLL414	8L updated	
	• Table 8 "Ch	aracteristics": V _F condition	s for PMLL4148L up	dated	
	• Figure 4: ur	hit for I_R in axis description	amended to μA		
	Section 13 '	"Legal information": update	ed		
PMLL4148L_PMLL4448_6	20050404	Product data sheet	-	PMLL4148L_4448_5	
PMLL4148L_4448_5	20020123	Product specification	-	PMLL4148L_4448_4	
PMLL4148L_4448_4	20001115	Product specification	-	PMLL4148_3	
PMLL4148_3	19990527	Product specification	-	PMLL4148_2	
PMLL4148_2	19960918	Product specification	-	PMLL4148_1	
PMLL4148_1	19960423	Product specification			

Table 10. Revision history

13. Legal information

13.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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